

Preface

Cautions

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2. START-UP INSTRUCTIONS

2.1. Installing the Evaluation Development Kit (EDK)

Please refer to the quick start guide provided for initial installation of the EDK.

A copy of the quick start guide and other information relating to this EDK at:

http://www.hmse.com/products/support.htm

Installing the EDK requires power and serial connection to a host computer.

2.2. SERIAL CONNECTION

The serial communications cable for connecting the EDK to a host computer is supplied. The serial cable has 1:1 connectivity.

Figure 2-1 shows how to connect the EDK to a PC or notebook computer equipped with a nine pin D connector.

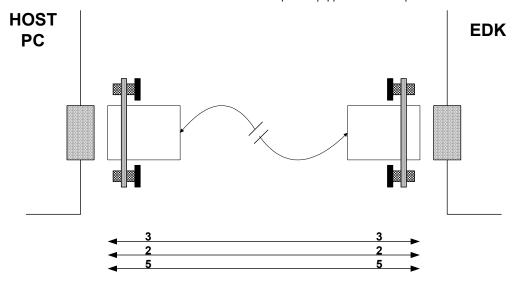


FIGURE 2-1: SERIAL CONNECTION TO PC/NOTEBOOK WITH DB-9 CONNECTOR (SUPPLIED)

2.3. POWER SUPPLY

The EDK hardware requires a power supply of +5V. Since total power consumption can vary widely due to external connections, port states, and memory configuration, use a power supply capable of providing at least 500mA at +5V DC ± 5%.

The design is specified for evaluation of the microcontroller and so does not include circuitry for supply filtering/noise reduction, under voltage protection, over current protection or reversed polarity protection. Caution should be used when selecting and using a power supply.

The power connector on the EDK is a 2.5mm Barrel connector. The center pin is the positive connection.

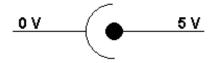


FIGURE 2-2: POWER SUPPLY CONNECTION

Caution: Existing customers using E6000 products note that the polarity of this board is opposite to that for the E6000. Use of the E6000 power supply with this board will damage both board and power supply.

3. EDK BOARD LAYOUT

The diagram shows a general layout of the EDK board.

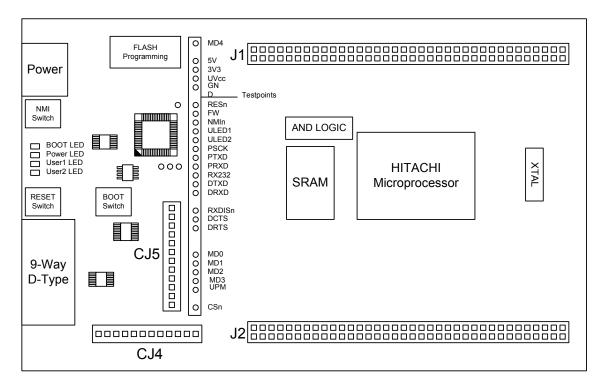


FIGURE 3-1: EDK BOARD LAYOUT

3.1. EDK BLOCK DIAGRAM

The diagram shows the connectivity of the components on the EDK board.

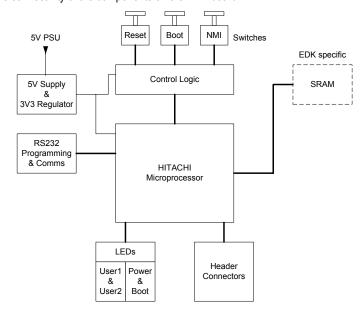


FIGURE 3-2: EDK BLOCK DIAGRAM

4. EDK OPERATION

4.1. USER INTERFACE

The EDK provides three buttons for influencing the operation of the board. The purpose of each button is clearly marked next to it. Refer to the board layout for positions (Section 3)

1. Reset Switch

This button provides the microcontroller with a timed reset pulse of at least 250mS.

2. Boot Switch

This button toggles the operating mode of the microcontroller. A complete description of this function is given in section 5.6.

3. NMI Switch

This button provides a de-bounced signal to the microcontroller for each operation of the button. There is no minimum or maximum activation time for this button.

4.2. SERIAL INTERFACE

The serial interface on the EDK board has several functions. The serial port on the microcontroller directly supports three wire serial interfaces. Options are provided on the board for the user to write handshaking routines using standard port pins. Other board option links allow users to control the entry and exit from boot mode using the same handshaking signals. Refer to section 5 for details on setting serial interface options.

4.2.1. CONNECTOR PIN DEFINITIONS

The EDK RS232 interface conforms to Data Communication Equipment (DCE) format allowing the use of 1-1 cables when connected to Data Terminal Equipment (DTE) such as an IBM PC. The cable used to connect to the EDK will affect the available board options. A fully wired cable can allow handshaking between the microcontroller and the host PC, subject to setting the board options and the availability of suitable host software. Handshaking is not supported as standard on the microcontroller so for normal use a minimal three-wire cable can be used. The minimum connections are unshaded in the following table.

EDK DB9	Signal	Host DB9
Connector Pin		Connector Pin
1	No Connection	1
2	EDK Tx Host Rx	2
3	EDK Rx Host Tx	3
4	No Connection	4
5	Ground	5
6	No Connection	6
7	* EDK CTS Host RTS	7
8	* EDK RTS Host CTS	8
9	No Connection	9

TABLE 4-1: RS232 INTERFACE CONNECTIONS

^{*} These are not connected on the EDK by default. See section 5.4 for more details.

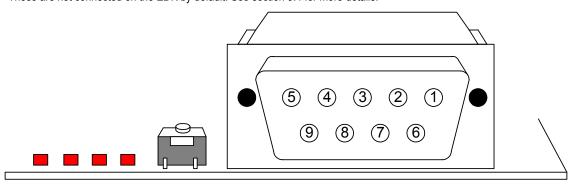


FIGURE 4-1: EDK SERIAL PORT PIN NUMBERING

4.2.2. CRYSTAL CHOICE

The operating crystal frequency has been chosen to support the fastest operation with the fastest serial operating speeds. The value of the crystal is 22.1184MHz.

The following table shows the baud rates and Baud Rate Register (BRR) setting required for each communication rate using the above default operating speed. It also confirms the resultant baud rate and the bit error rate that can be expected.

	Baud Rate Register Settings for Serial Communication Rates											
SMR		0			1			2			3	
Setting:												
Comm.	BRR	Actual	ERR	BRR	Actual	ERR	BRR	Actual	ERR	BRR	Actual	ERR
Baud	setting	Rate	(%)	setting	Rate	(%)	setting	Rate	(%)	setting	Rate	(%)
110	invalid	invalid	invalid	invalid	invalid	invalid	invalid	invalid	invalid	97	110.20	0.19
300	invalid	invalid	invalid	invalid	invalid	invalid	143	300	0.00	35	300	0.00
1200	invalid	invalid	invalid	143	1200	0.00	35	1200	0.00	8	1200	0.00
2400	invalid	invalid	invalid	71	2400	0.00	17	2400	0.00	4	2160	-10.00
4800	143	4800	0.00	35	4800	0.00	8	4800	0.00	1	5400	12.50
9600	71	9600	0.00	17	9600	0.00	4	8640	-10.00	0	10800	12.50
19200	35	19200	0.00	8	19200	0.00	1	21600	12.50	invalid	invalid	invalid
38400	17	38400	0.00	4	34560	-10.00	0	43200	12.50	invalid	invalid	invalid
57600	11	57600	0.00	2	57600	0.00	invalid	invalid	invalid	invalid	invalid	invalid
115200	5	115200	0.00	1	86400	-25.00	invalid	invalid	invalid	invalid	invalid	invalid
230400*	2	230400	0.00	invalid								
460800*	1	345600	-25.00	invalid								

TABLE 4-2 CRYSTAL FREQUENCIES FOR RS232 COMMUNICATION

The default communication rate for the EDK is indicated by the shaded selection.

The user may replace the HC49/U surface mounted AT cut crystal with another of similar type within the operating frequency of the microcontroller device. Please refer to the hardware manual for the microcontroller for the valid operating range.

Alternatively the user may fit an oscillator module – or provide an external clock source. When providing an oscillator module or external source it is highly recommended that the load capacitors for the AT crystal are removed from the PCB. These are physically placed within the PCB outline of the oscillator module for easy location and to ensure they are removed when using this option.

When changing the crystal frequency the pre-loaded debugging monitor will not function. In this situation the user is responsible for providing code to evaluate the device away from the default operating speed.

4.2.3. REMOVABLE COMPONENT INFORMATION.

This information is provided to allow the replacement of components removed from the board as described in section 4.2.2.

Component	Cct. Ref	Value	Rating	Manufacturer
Load Resistor (X2)	R15	1ΜΩ	0805 1%	Welwyn WCR Series
Load capacitors (X2)	C11,12	10pF	0603 10% 25V	AVX 0603 3 A 150 KAT

TABLE 4-3: REMOVABLE COMPONENT INFORMATION

Care must be taken not to damage the tracking around these components. Only use soldering equipment designed for surface mount assembly and rework.

4.3. **SRAM**

The SRAM device fitted to the board is a 4Mbit device allowing 256 x 16 operation. EDK3069 supports only 16-bit access.

The H8/3069 microcontroller has chip select management built in. There is no external chip selection hardware associated with this device. The SRAM is connected to Chip Select 0 (CS0), which can address the range H'00080000 – H001FFFFF. However, as the SRAM is 4Mbit in size, the highest accessible address is H'000FFFFF.

Provision has been made for disabling the connection between the glue logic and the lower-byte select of the SRAM via jumper link CJ4 (pins 8 - 9).

^{*} Note: The device used to convert the RS232 serial information to logic signals for the microcontroller is limited to 120kBaud. The rates above this level can only be utilised if the user provides direct logic level communications.

4.4. MEMORY MAP

Table 4-4 illustrates the EDK memory map for mode 5.

Section Start Section End	Section Allocation
H'000000	On – Chip ROM
H'07FFFF	
H'080000	External Address Space
H'FEDFFF	
H'FEE000	Internal I/O Registers (1)
H'FEE0FF	
H'FEE100	External Address Space
H'FFBF1F	
H'FFBF20	On-Chip RAM
H'FFFF1F	
H'FFFF20	Internal I/O Registers (2)
H'FFFFE9	
H'FFFFEA	External Address Space
H'FFFFFF	

TABLE 4-4: MEMORY MAP (DEFAULT MODE 5)

4.5. SRAM Access Timing

External access timing is defined by several registers, allowing different types of devices to be addressed. The registers for the selection of wait states and signal extensions are given below with recommended values for the EDK.

Register	Address	Recommended	Function
		Setting for EDK	
BCR	H'EE024	Default	En/disables idle cycle insertion, selects address map, area division unit and
			burst ROM parameters.
ABWCR	H'EE020	0x00	Sets up access as 16-bit for each memory area
P1DDR,	H'EE000,	0xFF	Allows ports 1 and 2 to be used as address lines as it sets these ports as outputs.
P2DDR	H'EE001		
P5DDR	H'EE004	0xF7	Sets bits 2 to 0 on port 5 as output for address lines A16 to A18.
P8DDR	H'EE007	Bit 0 set to 1	This enables chip select 0
WCRL	H'EE023	0x01	Specifies 1 wait cycle for CS0 space.

TABLE 4-5: SRAM ACCESS CONTROL REGISTERS

Please refer to the hardware manual for the microcontroller for more information on these register settings.

4.6. LEDs

The EDK has four red LEDs. The function of each LED is clearly marked on the silk screen of the PCB. Please refer to the board layout diagram for position information (Section 3).

When the board is connected to a power source the Power (PWR) led will illuminate. The Boot mode indication LED will illuminate when the microcontroller has been placed into Boot mode. Please see section 5.6 for more details of this function.

There are two LEDs dedicated for user control these are marked USR1 and USR2. Each LED will illuminate when the port pin is in a logical high state.

The user LEDs are connected to the following ports:

LED Identifier	Port Pin	Microcontroller Pin	Pin Functions on Port Pin
USR1	PA2	Pin 95	TP0/TCLKA/TEND0n/PA0
USR2	PA3	Pin 96	TP1/TCLKB/TEND1n/PA1

TABLE 4-6: LED PORT CONNECTIONS

5. BOARD OPTIONS

The EDK has a number of configuration settings set by jumpers CJ4 (A, B, C, D) CJ5 (A, B, C, D) and zero-ohm links. Common EDK functions can be set using the jumpers as described in sections 5.3 and 5.2. The additional zero-ohm links provide additional features that may be required to interface with other systems.

All the Jumper link settings are three pin options. There are four sets of options on each header.

The headers are numbered from 1 to 12 with pin 1 marked on the PCB by an arrow pointing to the pin. The diagram below shows the numbering of these jumper links and indicates jumpers fitted 1-2 for each three-pin jumper.

5.1. JUMPER LINKS

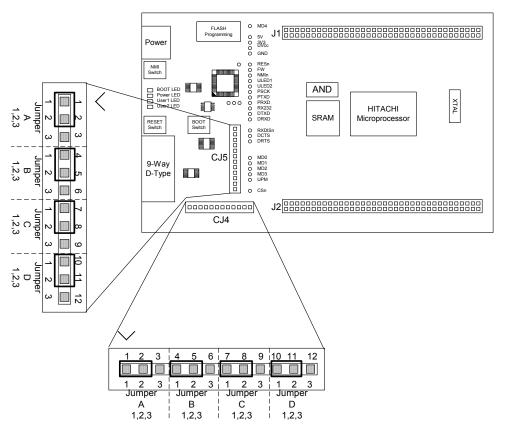


FIGURE 5-1: JUMPER CONFIGURATION

The following tables define each jumper and its settings.

5.2. USER MODE SETTINGS – CJ5

CJ5 is used to set the operating mode of the microcontroller.

These jumpers must be fitted at all times to ensure correct operation of the EDK.

Jumper	Function	Setting 1-2	Setting 2-3
CJ 5-A Default 1-2	User Mode Setting Bit 0	MD0 pulled High	MD0 pulled Low
CJ 5-B Default 2-3	User Mode Setting Bit 1	MD1 pulled High	MD1 pulled Low
CJ 5-C Default 1-2	User Mode Setting Bit 2	MD2 pulled High	MD2 pulled Low
CJ 5-D Default 1-2	User Mode Setting Bit 3	MD3 pulled High [NOT USED]	MD3 pulled Low [NOT USED]

TABLE 5-1: USER MODE: JUMPER SETTINGS (DEFAULT SETTINGS IN BOLD)

The default settings indicated in bold text place the microcontroller into Mode 5.

5.3. EDK OPTIONS - CJ4

The EDK options provide access to commonly used features of the EDK range.

These jumpers must be fitted at all times to ensure correct operation of the EDK.

Jumper	Function	Setting 1-2	Setting 2-3
CJ 4-A Default 2-3	Serial Receive Source	Disables the RS232 receive signal to enable the use of the Flash Programming Header	Enables the RS232 receive signal. The Flash Programming Header* must not be used in this state.
CJ 4-B Default 2-3	User Programming Mode	Disables the Flash write hardware protection. The flash can be overwritten in User Mode.	Enables the Flash write hardware protection. The flash can not be overwritten in User Mode.
CJ 4-C Default 2-3	Chip Select Disable	SRAM is enabled; port 8, pin 4 of the microcontroller is connected to the chip select of the SRAM.	SRAM is disabled. The chip select of the SRAM is a No Connect.
CJ 4-D Default 1-2	Boot / User Boot Mode selection	Microcontroller enters Boot mode on reset	Microcontroller enters User Boot mode on reset

TABLE 5-2: BOARD OPTION: JUMPER SETTINGS (DEFAULT SETTINGS IN BOLD)

The following table lists the connections to each jumper pin.

Pin	Net Name	Description
1	UVCC	Microcontroller Supply Voltage
2	RXDISn	Disable Flash Header functions. Pulled low. (Enables RX232)
3	No Connection	No Connection
4	UVCC	Microcontroller Supply Voltage
5	UPM	CPLD Controlled option to set Flash Write (FW). Pulled low.
6	No Connection	No Connection
7	P84	CS0 of microcontroller
8	CSn	Chip select of SRAM
9	No Connection	No Connection
10	UVCC	Pull up to Power supply via 4k7 resistor
11	BOOT_NMI	NMI signal is used to control entry into either boot or user boot mode on a reset.
12	Ground	Pull down to ground.

^{*}See section 5.5

5.4. SERIAL PORT SELECTION

The programming serial port is connected to the RS232 connector by default. This allows direct programming of the EDK using the supplied software tools. A secondary serial port is available on the microcontroller and can be connected to the RS232 connector by changing some board option links. The additional port option allows the user to write messages or connect to other devices via the serial port while programming support is provided by the Flash programming header.

The following surface mount, zero-ohm link settings are fitted by default and connect the RS232 header to the programming serial port of the microcontroller.

Zero-ohm Link ID	Default	Function	Microcontroller Port Pin
CR20	Fitted	Transmit data from EDK	P91
CR23	Fitted	Receive data to EDK	P93
CR19	Not Fitted	Alternate Transmit data from EDK	P90
CR22	Not Fitted	Alternate Receive data to EDK	P92

TABLE 5-3: OPTION LINKS - DEFAULT SETTINGS

To enable the use of this alternate port the user must change the settings to those in the following table.

Zero-ohm Link ID	Default	Function	Microcontroller Port Pin
CR20	Not Fitted	Transmit data from EDK	P91
CR23	Not Fitted	Receive data to EDK	P93
CR19	Fitted	Alternate Transmit data from EDK	P90
CR22	Fitted	Alternate Receive data to EDK	P92

TABLE 5-4: OPTION LINKS - ALTERNATE SERIAL PORT

The user may implement a handshaking protocol on the EDK. This is not supported with the software tools supplied. To support this option two spare port pins have been allocated on the microcontroller. Using these port pins the CTS and RTS lines of the host serial interface can be controlled.

The user may also control the operation of the board via the same handshaking lines. This is not supported with the software tools supplied but may be written by the user. Using the CTS line the user may simulate pressing the boot button, see section:5.6. This will cause the EDK to swap into and out of Boot mode on each low-level activation of CTS. Feedback of the current mode is provided on the RTS line. A high level indicates boot mode and a low level indicates user mode.

The following settings are made by default, and ensure that there are no conflicts on unnecessary microcontroller pins.

Zero-ohm Link ID	Default	Function	Microcontroller Port Pin
CR12	Not Fitted	Mode State out from EDK	N/A (From CPLD*)
CR7	Not Fitted	Change Mode request to EDK	N/A (From CPLD*)
CR16	Not Fitted	Alternate RTS232 – Ready to send – from EDK	P81
CR13	Not Fitted	Alternate CTS232 – Clear to send – to EDK	P80

TABLE 5-5: OPTION LINKS - SERIAL PORT CONTROL

Note: These setting pairs are exclusive:

If CR12 and CR7 are fitted; CR16 and CR13 must not be fitted. If CR16 and CR13 are fitted; CR12 and CR7 must not be fitted.

5.5. FLASH PROGRAMMING HEADER

The Flash Programming header is used with the Hitachi Flash Debug Board (FDB). The FDB is a USB based programming tool for control and programming of Hitachi microcontrollers, available separately from Hitachi. This header provides direct access for the FDB to control the EDK microcontroller.

To utilise this header the user must make the following changes to the board configuration.

- Disable the RX232 signal from the RS232 transceiver.
 Jumper link CJ4-A is provided for this purpose. Please refer to section 5.3.
- 2. Disable User Program Mode using jumper CJ4-B. Please refer to section 5.3.

Caution: Do not operate the board with the user mode jumpers removed and the FDB disconnected as the microcontroller mode pins will float to an indeterminate state. This may damage the microcontroller device.

^{*} See section 5.6

5.6. BOOT AND USER BOOT CONTROL

The timing of specific control signals required for placing the microcontroller device into any mode for reprogramming or running software is performed by a complex programmable logic device (CPLD). This device detects a power up event and provides a timed reset pulse to guarantee the reset of the microcontroller. At the end of the reset pulse the processor will be placed in user mode and any code in the device will execute. The CPLD is not necessary for most user designs, but allows increased flexibility for the EDK designs. Factually, mode transitions including boot mode transitions require the reset and / or the FWE pin to be held active while the appropriate mode settings are presented to the microcontroller. On releasing reset, the microcontroller will then be in the required mode of operation. The value at the mode pins must not however, be altered during the operation of the microcontroller.

During user mode the NMI button can be pressed at any time. This will provide a single de-bounced NMI interrupt to the device.

Pressing the boot button will cause the boot mode controller to reset the device and, during the reset period, present the required mode settings to start the device in either boot or user boot mode. The setting of jumper 4 on CJ4 determines whether the microcontroller enters user boot mode or boot mode (See section 5.3). At the end of the reset period the boot mode settings will have been latched into the device which will then be ready to accept a boot / user boot mode connection via the RS232 interface or the flash programming header. Pressing the boot button during a normal reset will not cause the FDK to enter either boot mode or user boot mode.

The boot mode settings are fixed at mode 1. The required mode settings are made using a tri-state capable buffer.

Note: The boot control device is programmed to support all possible EDK products.

For this reason the reset pulse is over 500ms. Repetitive activation of either the Boot or Reset buttons will restart the reset timer and extend the reset period. Pressing the boot button within the 500mS period of a reset will not cause the board to enter boot mode.

5.6.1. UTILISATION NOTES FOR USER BOOT MODE

A Note on Mats:

The H8/3069 possesses two distinct areas of Flash, User MAT (512KByte) and User Boot MAT (8KByte). The User Boot MAT is a separate area of FLASH from User MAT, intended to hold user boot code.

User Boot Mode:

A custom boot stub could be programmed into User Boot MAT which allows programming and erasing of the User MAT in User Mode, without erasing the contents of the User Boot MAT. Once User Boot Mode is entered, code contained in the User Boot MAT is executed. This differs to Boot mode, as Boot mode erases all User MAT and requires an auto-baud on a fixed SCI port to be performed. The existence of the user boot Mat therefore allows an alternative communications port to be used for further code download to the User MAT. Programming of the user boot mat can, however, only be performed in boot mode.

For entry to User Boot mode on EDK3069, jumper D on jumper block CJ4 must be fitted 11-12, then the boot button depressed once. The Boot LED should light, suggesting a transition to user boot mode.

5.6.2. CPLD CODE

The code is based upon a four state machine providing a guaranteed reset period which can be extended by holding the relevant control input in the active state. When released the timer will extend the reset for approximately 500mS.

The states are split into two functions, one for User mode and one for Boot mode. The first state of each is used to hold the reset line active. When the timer expires then the second state is used to hold the device in the selected mode and wait for an external control signal to either move back into the user reset state or into the boot reset state.

5.6.3. STATE DIAGRAM

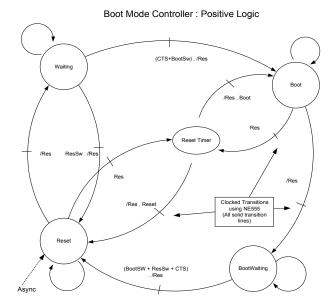


FIGURE 5-2: CPLD STATE DIAGRAM

6. MICROCONTROLLER HEADER CONNECTIONS

The following table lists the connections to each or the headers on the board.

6.1. HEADER J1

	J1						
Pin	Function	EDK	Device	Pin	Function	EDK Symbol	Device
No		Symbol	pin	No			pin
1	VSS	GND	11	2	FWE	FW	10
3	PB7/RxD2/TP15	PB7	9	4	PB6/TxD2/TP14	PB6	8
5	PB5/SCK2/LCASn/TP13	PB5	7	6	PB4/UCASn/TP12	PB4	6
7	PB3/CS4n/DREQ1n/TMIO3/TP11	PB3	5	8	PB2/CS5n/TMO2/TP10	PB2	4
9	PB1/CS6n/DREQ0n/TMIO1/TP9	PB1	3	10	PB0/CS7n/TMO0/TP8	PB0	2
11	Vcl	NC_J1_11	1	12	PA7/TP7/TIOCB2/A20	PA7	100
13	PA6/TP6/TIOCA2/A21	PA6	99	14	PA5/TP5/TIOCB1/A22	PA5	98
15	PA4/TP4/TIOCA1/A23	PA4	97	16	PA3/TP3/TIOCB0/TCLKD	ULED2	96
17	PA2/TP2/TIOAC0/TCLKC	ULED1	95	18	PA1/TP1/TCLKB/TEND1n	PA1	94
19	PA0/TP0/TCLKA/TEND0n	PA0	93	20	Vss	GND	92
21	P84/CS0n	P84	91	22	P83/IRQ3n/CS1n/ADTRGn	P83	90
23	P82/IRQ2n/CS2n	P82	89	24	P81/IRQ1n/CS3n	DRTS	88
25	P80/IRQ0n/RFSHn	DCTS	87	26	AVss	CON_AVSS	86
27	P77/AN7/DA1	P77	85	28	P76/AN6/DA0	P76	84
29	P75/AN5	P75	83	30	P74/AN4	P74	82
31	P73/AN3	P73	81	32	P72/AN2	P72	80
33	P71/AN1	P71	79	34	P70/AN0	P70	78
35	VREF	CON_VREF	77	36	AVcc	CON_AVCC	76
37	MD2	MD2	75	38	MD1	MD1	74
39	MD0	MD0	73	40	P66/LWRn	P66	72
41	P65/HWRn	P65	71	42	P64/RDn	P64	70
43	P63/Asn	P63	69	44	Vcc	UVCC	68
45	XTAL	CON_XTAL	67	46	EXTAL	CON_EXTAL	66
47	Vss	GND	65	48	NMI	NMIn	64
49	RESn	RESn	63	50	STBYn	STBYn	62

6.2. HEADER J2

	J2						
Pin No	Function	EDK Symbol	Device pin	Pin No	Function	EDK Symbol	Device pin
1	P90/TxD0	P90	12	2	P91/TxD1	PTXD	13
3	P92/RxD0	P92	14	4	P93/RxD1	PRXD	15
5	P94/IRQ4n/SCK0	P94	16	6	P95/IRQ5n/SCK1	PSCK	17
7	P40/D0	P40	18	8	P41/D1	P41	19
9	P42/D2	P42	20	10	P43/D3	P43	21
11	VSS	VSS	22	12	P44/D4	P44	23
13	P45/D5	P45	24	14	P46/D6	P46	25
15	P47/D7	P47	26	16	P30/D8	P30	27
17	P31/D9	P31	28	18	P32/D10	P32	29
19	P33/D11	P33	30	20	P34/D12	P34	31
21	P35/D13	P35	32	22	P36/D14	P36	33
23	P37/D15	P37	34	24	Vcc	UVCC	35
25	P10/A0	P10	36	26	P11/A1	P11	37
27	P12/A2	P12	38	28	P13/A3	P13	39
29	P14/A4	P14	40	30	P15/A5	P15	41
31	P16/A6	P16	42	32	P17/A7	P17	43
33	VSS	VSS	44	34	P20/A8	P20	45
35	P21/A9	P21	46	36	P22/A10	P22	47
37	P23/A11	P23	48	38	P24/A12	P24	49
39	P25/A13	P25	50	40	P26/A14	P26	51
41	P27/A15	P27	52	42	P50/A16	P50	53
43	P51/A17	P51	54	44	P52/A18	P52	55
45	P53/A19	P53	56	46	Vss	GND	57
47	P60/WAITn	P60	58	48	P61/BREQn	P61	59
49	P62/BACKn	P62	60	50	P67/Φ	P67	61

7. CODE DEVELOPMENT

7.1. HMON

7.1.1. MODE SUPPORT

The HMON library is built to support Modes 1, 2, 3, 4, 5 and 7. The Device supports only these modes.

7.1.2. Breakpoint Support

The monitor utilises traps which have vectors located in ROM. User code located in RAM may have multiple breakpoints limited only by the size of the On-Chip RAM.

7.1.2.1.CODE LOCATED IN FLASH / ROM

Double clicking in the breakpoint column in the code sets the breakpoint. Adding a further breakpoint elsewhere in the code removes the previous one.

7.1.2.2.CODE LOCATED IN RAM

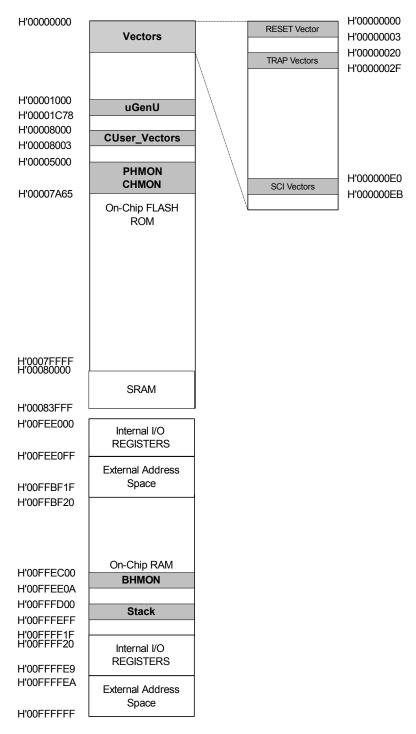
Double clicking in the breakpoint column in the code sets the breakpoint. Breakpoints will remain unless they are double clicked to remove them.

7.1.3. HMON CODE SIZE

HMON is built along with the debug code. Certain elements of the HMON code must remain at a fixed location in memory. The following table details the HMON components and their size and location in memory. For more information, refer to the map file when building code.

Section	Description	Start Location	Size (H'bytes)
RESET_VECTOR	HMON Reset Vector (Vector 0) Required for Startup of HMON	H, 00000000	4
TRAP_VECTORS	Trap Vectors (Vector 8, 9, 10, 11) Required by HMON to create Trap Breakpoints in RAM	H' 00000020	10
SCI_VECTORS	HMON Serial Port Vectors (Vector 80, 81, 82, 83) Used by HMON when EDK is configured to connect to the default serial port.	H' 000000E0	С
UGenU	FDT User Mode Kernel. This is at a fixed location and must not be moved. Should the kernel need to be moved it must be re-compiled.	H' 00001000	C79
PHMON	HMON Code	H' 00005000	2928
CHMON	HMON Constant Data	H' 00007928	13E
BHMON	HMON Uninitialised data	H' 00FFEC00	20B
CUser_Vectors	Pointer used by HMON to point to the start of user code. This is at a fixed location and must not be moved for the Reset CPU, and Go Reset commands to function.	H' 00008000	4

7.1.4. MEMORY MAP



7.1.5. BAUD RATE SETTING

HMON has initially set to connect at 115200Baud. Should the user wish to change this, the value for the BRR in HMONserialconfiguser.c will need to be changed and the project re-built. Please refer to the HMON User Manual for further information.

7.1.6. INTERRUPT MASK SECTIONS

HMON has an interrupt priority of 1. The serial port has an interrupt priority of 1. Modules using interrupts should be set to lower than this value so that serial communications and debugging capability is maintained.

7.1.7. LIMITATIONS OF USE FOR HMON

H8/3069 has two interrupt levels for each interrupt, which can be defined as 1 or 0. Whilst the monitor is running, the condition code register is set up such that interrupts with a priority level of less than 1 are not accepted. This does not prevent users code from allowing interrupts of priority level 0 in the condition code register, but these interrupts will only be accepted whilst the user code is running.

7.2. ADDITIONAL INFORMATION

For details on how to use Hitachi Embedded Workshop (HEW), with HMON, `refer to the HEW manual available on the CD or from the web site.

For information about the H8/3069 series microcontrollers refer to the H8/3069 Series Hardware Manual

For information about the H8/300H assembly language, refer to the H8/300H Series Programming Manual

Further information available for this product can be found on the HMSE web site at:

http://www.hmse.com/products/support.htm

General information on Hitachi Microcontrollers can be found at the following URLs.

Global: http://www.hitachisemiconductor.com

Europe: http://www.hmse.com